

HIGH-SPEED SWITCHING/SILICON EPITAXIAL TYPE
(SERIES TYPE)

DESCRIPTION

The MC931 is a silicon epitaxial double diode employing small epoxy molded package.

It is designed for high-speed switching applications.

Owing to the small terminal capacitance and the short switching time (reverse recovery time), this diode usable not only for high-speed switching applications but also for protection, bias and other circuits.

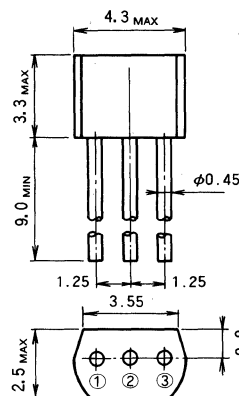
Moreover, this is small in size and double, it is suitable for high-density mounting applications.

FEATURES

- Small terminal capacitance
- High speed switching
- High voltage
- Two devices connected in series
- Good machining characteristics
- Double device and compact format reduce dimensions and enhance high-density mounting.

OUTLINE DRAWING

UNIT : mm



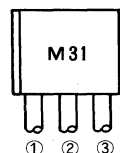
TERMINAL CONNECTIONS

- ① : ANODE 1
 ② : CATHODE 1 + ANODE 2 EIAJ : -
 ③ : CATHODE 2 JEDEC : -

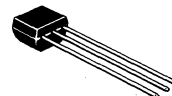
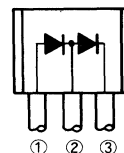
ABSOLUTE MAXIMUM RATINGS ($T_a=25^\circ\text{C}$)

Symbol	Parameter	Limits	Unit
V_{RM}	Peak reverse voltage	75	V
V_R	Reverse voltage	50	V
I_{FSM}	Forward surge current	4	A
I_{FM}	Peak forward current	300	mA
I_O	Average rectified current	100	mA
P_T	Power dissipation	300	mW
T_j	Junction temperature	+125	$^\circ\text{C}$
T_{stg}	Storage temperature	-55~+125	$^\circ\text{C}$

MARK



INTERNAL CONNECTIONS



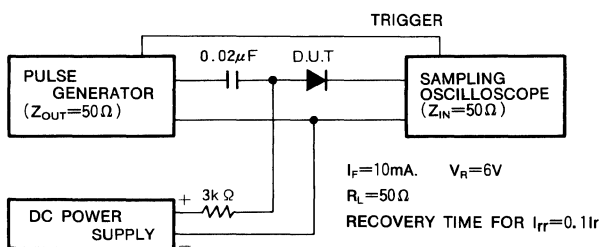
3-pin molded plastic SIL

ELECTRICAL CHARACTERISTICS ($T_a=25^\circ\text{C}$)

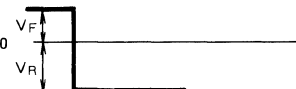
Symbol	Parameter	Test conditions	Limits			Unit
			Min	Typ	Max	
V_{F1}	Forward voltage	$I_F=10\text{mA}$		0.68	0.9	V
V_{F2}	Forward voltage	$I_F=50\text{mA}$		0.82	1.0	V
V_{F3}	Forward voltage	$I_F=100\text{mA}$		0.92	1.2	V
I_R	Reverse current	$V_R=50\text{V}$			0.1	μA
C_t	Terminal capacitance	$V_R=0, f=1\text{MHz}$		1.2	4.0	pF
t_{rr}	Reverse recovery time	(See measurement circuit)			4.0	ns

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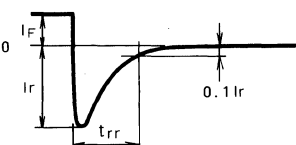
REVERSE RECOVERY TIME(T_{rr}) MEASUREMENT CIRCUIT



● INPUT VOLTAGE WAVEFORM

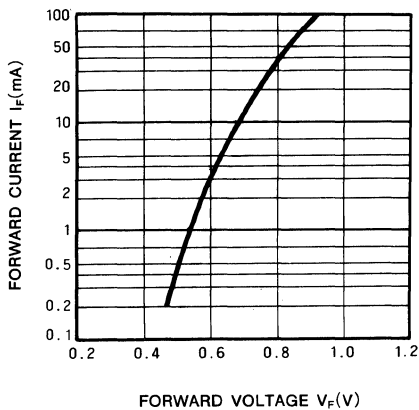


● WAVEFORM OF CURRENT FLOWING TO DIODE

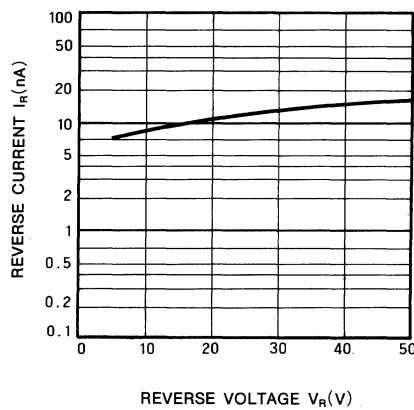


TYPICAL CHARACTERISTICS

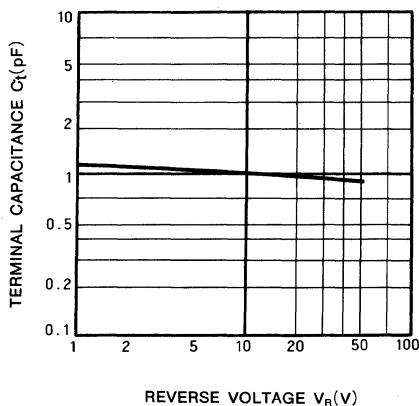
FORWARD CURRENT VS FORWARD VOLTAGE



REVERSE CURRENT VS REVERSE VOLTAGE



TERMINAL CAPACITANCE VS REVERSE VOLTAGE



REVERSE RECOVERY TIME VS FORWARD CURRENT

